

## DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought of the application entitled

## Semiconductor Chip Package and Method Of Fabricating The Same

which (check)	is attached hereto.					
	and is amended by the Preliminary Amendment attached hereto.					
	was filed on	as Application Serial No.				
	[] and was amended on (If applicable)					
I hereby state the	nat I have reviewed and understand the contents of laims, as amended by any amendment referred to a	f the above identified specification above.				

I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed:

	Priority Claimed			
Prior Foreign Application Number Country		Day/Month/Year Filed	Yes	No
1998-54972	Republic of Korea	15-Dec-1998	(X)	

I hereby claim the benefit under Title 35, United States Code, § 119(3) of any United States I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the United States Palent and Trademark Office connected therewith:

Alan H. MacPherson (24,423); Brian (). Ogonowsky (31,988); David W. Heid (25,875); Norman R. Klivans (33,003); Edward C. Kwok (33,938); David E. Steuber (25,557); Michael Shenker (34,250); Stephen A. Terrile (32,946); Peter H. Kang (40,350); Ronald J. Meetin (29,089); Ken John Koestner (33,004); Omkar K. Suryadevara (36,320); David T. Millers (37,396); Kent B. Chambers (38,839); Michael P. Adams (34,763); Robert B. Morrill (43,817); Michael J. Halbert (40,633); Gary J. Edwards (41,008); William B. Tiffany (41,347); James E. Parsons (34,691); Daniel P. Stewart (41,332); Philip W. Woo (39,880); John T. Winburn (26,822); Tom Chen (42,406); Fabio E. Marino (43,339); William W. Holl way (26,182); Don C. Lawrence (31,975); Marc R. Ascolese (42,268); Carmen C. Co k (42,433); David G. Dolezal (41,711); Roberta P. Saxon (43,087); Bernice Chen (42,403); Mary Jo Bertani (42,321); Dale R. Cook (42,434); Sam G. Campbell (42,381); Matthew J.



Docket No.: AB-881 US

Brigham (44,047); Glen B. Choi (43,546); Hugh II. Matsubayashi (43,779); Margaret M. Kelton (44,182); Joseph T. Vanl.ceuwen (44,383); Patrick D. Benedictor (40,909); T. J. Singh (39,535); Shireen Irani Bacon (40,494); Rory G. Bens (44,028); George W Iken, Jr. (30,441); John D. Odozynski (28,769); and Cameron K. Kerrigan (44,826).

Please address all correspondence and telephone calls to:

David T. Millers
Attorney for Applicant(s)

SKJERVEN, MORRILL, MacPHERSON, FRANKLIN & FRIEL LLP
25 Metro Drive, Suite 700

San Jose, California 95110-1349

Telephone: 408-453-9200 Facsimile: 408-453-7979

I declare that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penaltics including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

Full name of first joint	inventor: H	leung-Kyu	Kwon		
Inventor's Signature: Residence: Post Office Address:	Seongnam, Kyong 208-206 Mujigae-1 202 Gumi-dong, Po Seongnam, Kyong	He wa Kyn Kwon Seongnam, Kynnggi-do, Korea 208-206 Mujigae-maeul LG Apt., 103, 202 Gumi-dong, Pundang-gu, Seongnam. Kyonggi-do, Republic of Korea		Date: Citizenship:	1999 12.14 Republic of Korca
Full name of second join	nt inventor: <u>N</u>	<u>lin-Kyo Ch</u>	0		
Inventor's Signature: Residence: Post Office Address:	Seoul, Korca 833-28 Mia 2-don Seoul, Republic of			Date:	1999. 12.14 Republic of Korca